

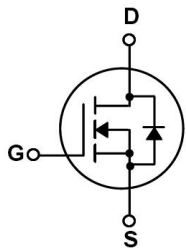
“Y / Descriptions

• È / Features

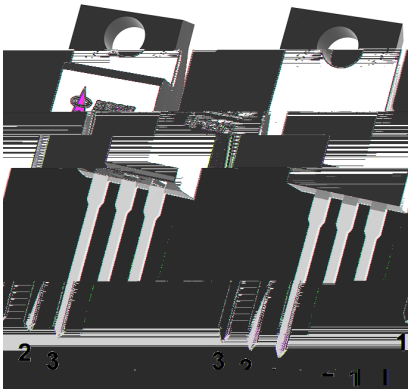
v / Applications

DC/DC

Л ~ α ≈ / Equivalent Circuit



ã / ù ~ / Pinning



£. H Ñ / Marking

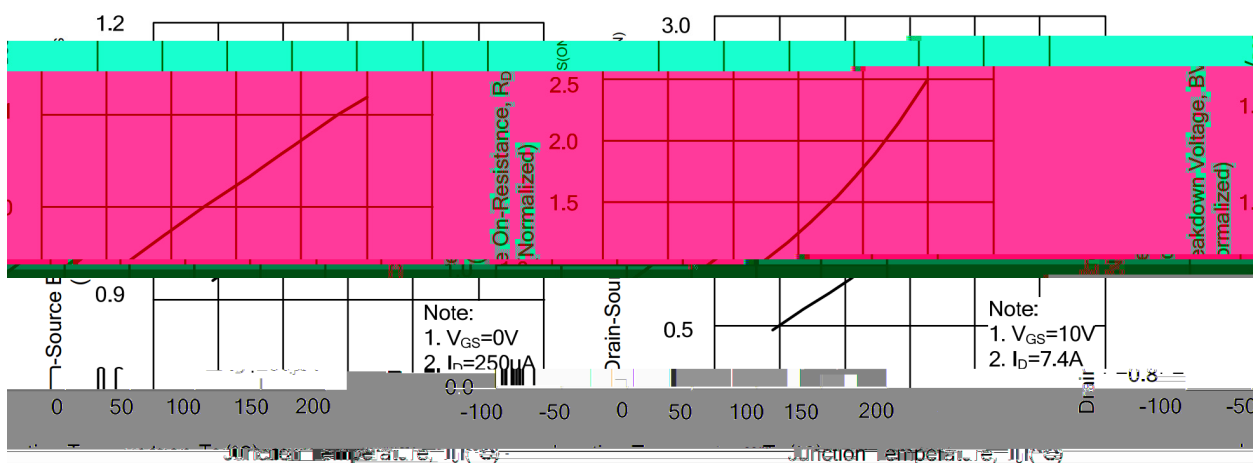
绝对最大额定值 / Absolute Maximum Ratings(Ta=25 ℃)

	℃		
	℃		
	℃		
	θ		℃
	θ		℃

电 气 特 性 / Electrical Characteristics(Ta=25 ℃)

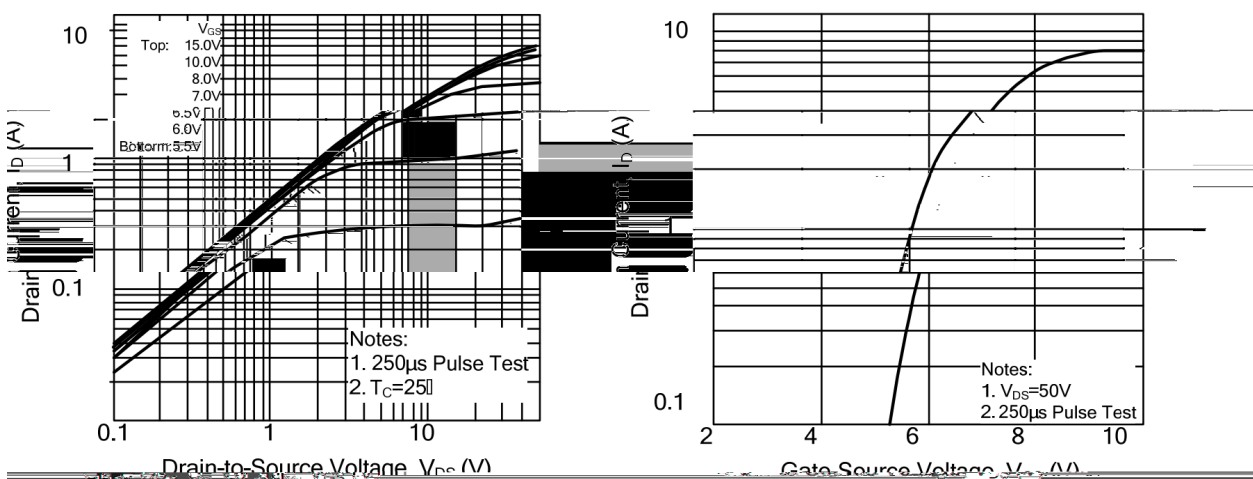
		μ				
						μ
		μ				
						Ω
		Ω				

Electrical Characteristic Curve



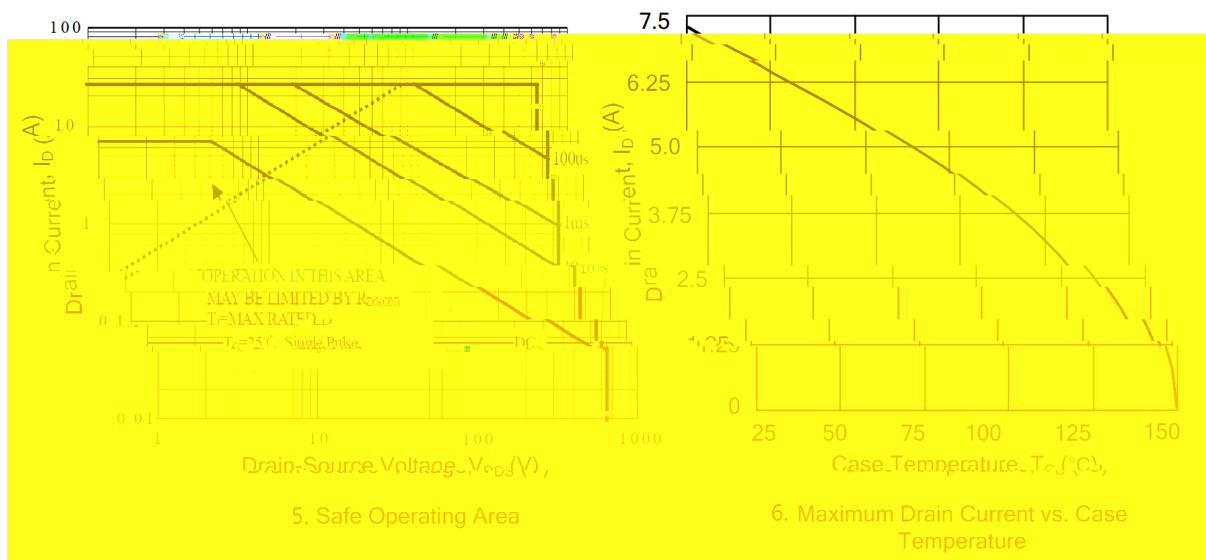
1. Breakdown Voltage Variation vs. Junction Temperature

2. On-Resistance Variation vs. Junction Temperature

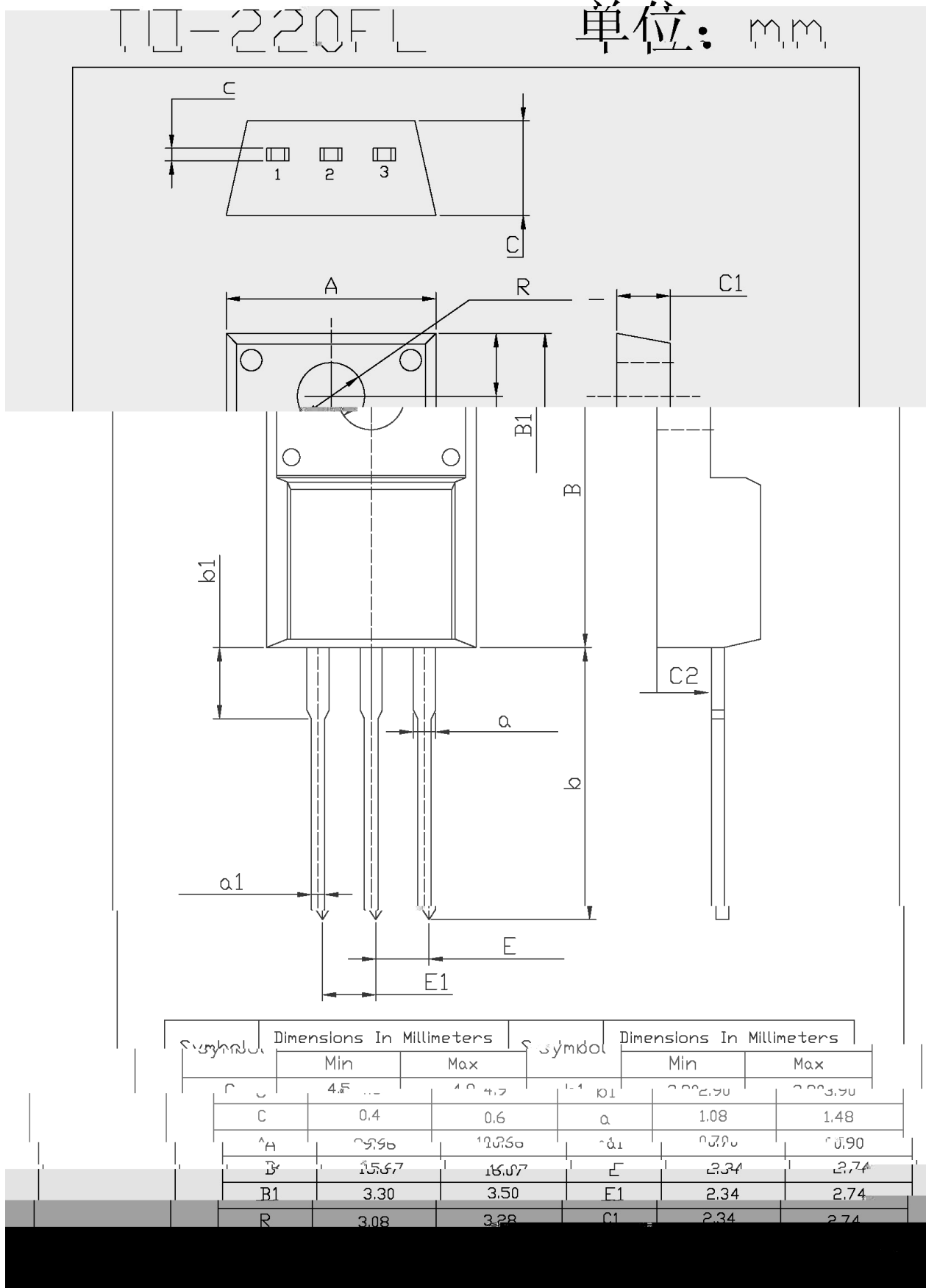


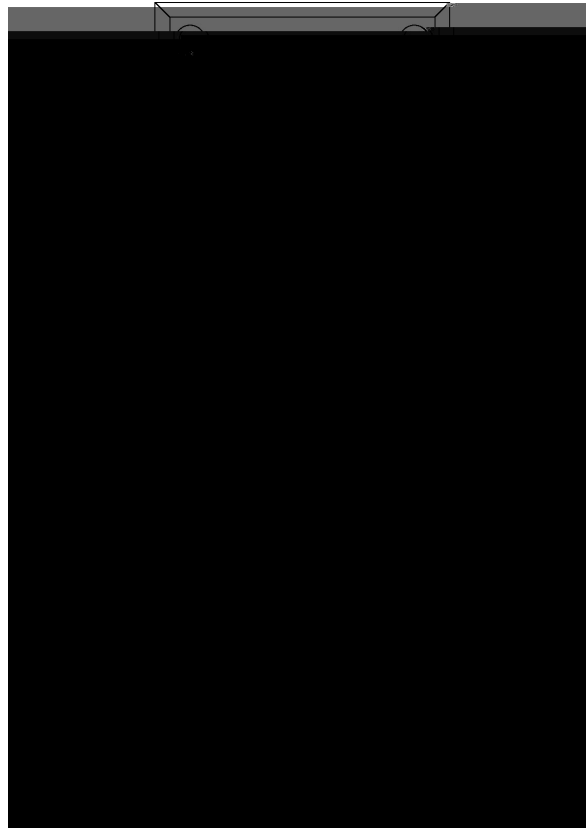
4. Transfer Characteristics

5. On-State Characteristics

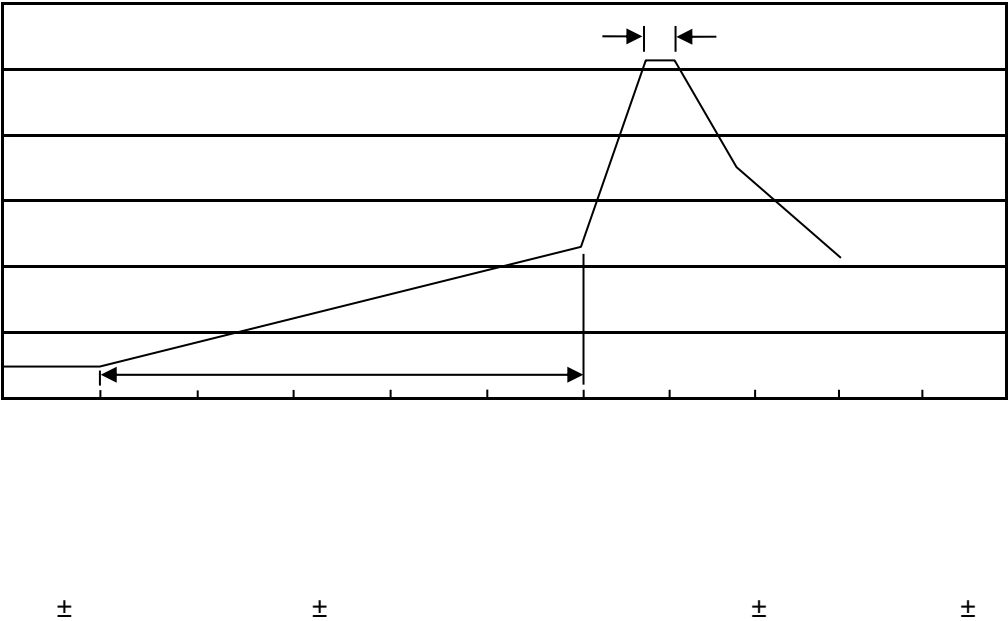


封装尺寸 / Package Dimensions





↓ § ¶ ŵ'E √ f (Ω) / Temperature Profile for Dip Soldering(Pb-Free)



↓ ũ 'Y ¶ / Resistance to Soldering Heat Test Conditions

± ±

¶ — / Packaging SPEC.

	Units/Tube /	Tubes/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Tube	Inner Box	Outer Box

ä v "Ω / Notices